

# CLX6F-GKB: PLCC6 3 IN 1 SMD LED



#### **PRODUCT DESCRIPTION**

These SMD LEDs are packaged in an industry standard PLCC6 package. These high reliability and high brightness LEDs are designed to work in a wide range of environmental condition and are ideally suited for use in illumination applications.

Its wide viewing angle makes these LEDs ideally suited for channel letter, or general backlighting and illumination applications. The flat top emitting surface makes it easy for these LEDs to mate with light pipes.

# FEATURES

- Size (mm): 3.5 x 3.4 x 2.8
- Dominant Wavelength: Green (520 - 540nm)
  - Luminous Intensity (mcd) CLX6F-GKB:(5020 - 9000)
  - Water-Resistant (IPX8)\*
  - Moisture Sensitivity Level: 5a
  - Lead-Free
  - RoHS Compliant
  - Matte Surface

#### **APPLICATIONS**

- Architecture Lighting
- Channel Letter
- Backlight

\*: This part is tested under the condition of assembling it on a PCB with isolating the electrical path by silicone. The leads area of the LED is not IPx8 rated and it's required to insulate for moisture by customer in outdoor application.

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# ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Items	Symbol	Absolute Maximum Rating	Unit		
Forward Current Note 1	I <sub>F</sub>	3 x 35	mA		
Peak Forward Current Note 2	I <sub>FP</sub>	3 x 100	mA		
Reverse Voltage	V <sub>R</sub>	5	V		
Power Dissipation	P <sub>D</sub>	3 x 126	mW		
Operation Temperature	T <sub>opr</sub>	-40 ~ +85	°C		
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C		
Junction Temperature	T <sub>J</sub>	110	°C		
Junction/Ambient 1 chip on	R <sub>THJA</sub>	400	°C/W		
Junction/Solder Point 1 chip on	R <sub>THJS</sub>	230 °C/W			
Electrostatic Discharge Classification (MIL-STD-883E)	ESD	1000V			

#### Note:

1. Single-color light

2. Pulse width  $\leq 0.1$  msec, duty  $\leq 1/10$ .

# TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS ( $T_A = 25^{\circ}C$ )

Characteristics	Condition	Symbol	Values	Unit
Dominant Wavelength	I <sub>F</sub> = 3 x 20mA	$\lambda_{_{DOM}}$	520~540	nm
Spectral bandwidth at 50% $\mathrm{I}_{\mathrm{REL}}$ max	I <sub>F</sub> = 3 x 20mA	Δλ	28	nm
Forward Voltage	I <sub>F</sub> = 3 x 20mA	V <sub>F(avg)</sub>	2.9	V
		V <sub>F(max)</sub>	3.6	V
Lumineus Intensity	I <sub>F</sub> = 3 x 20mA	l <sub>V(min)</sub>	5020	mcd
Luminous Intensity		l <sub>V(avg)</sub>	7100	mcd
Luminous Flux(Reference)	I <sub>F</sub> = 3 x 20mA	$\Phi_{_{V(avg)}}$	19.6	lm
Reverse Current (max)	V <sub>R</sub> = 5 V	I <sub>R</sub>	10	μA

\* Continuous reverse voltage can cause LED damage.



### **INTENSITY BIN LIMIT**

Blue(3 x 20 mA) - CLX6F-GKB			
Bin Code	Min.(mcd)	Max.(mcd)	
1h1j	5020	6300	
W	5600	7100	
1k1m	6300	8000	
Х	7100	9000	

\* Tolerance of measurement of luminous intensity is ±10%

# **COLOR BIN LIMIT**

Blue (3 x 20 mA) - CLX6F-GKB				
Bin Code	Min.(nm)	Max.(nm)		
G7	520	525		
G23	522.5	527.5		
G8	525	530		
G45	527.5	532.5		
G9	530	535		
G67	532.5	537.5		
Ga	535	540		

\* Tolerance of measurement of dominant wavelength is ±1 nm

#### **ORDER CODE TABLE**

Color Kit Number		Luminous Intensity (mcd)		Dominant Wavelength (nm)				Package
Color	Color Kit Number	Min.	Max.	Color Bin	Min.(nm)	Color Bin	Max.(nm)	Гаскауе
Green	CLX6F-GKB-C1h1jX7a3	5020	9000	G7	520	Ga	540	Reel
Green	CLX6F-GKB-C1h1j17D3	Any 1 Intensity bin from 1h1j(5020) - X(9000)		Any 1 hue bin from G7(520) - Ga(540)			Reel	

Notes:

• The above kit numbers represent order codes that include multiple intensity-bin and color-bin codes. Only one intensity-bin code and one color-bin code will be shipped on each bulk. Single intensity-bin code and single color-bin codes will not be orderable.

Please refer to the HB LED Lamp Reliability Test Standards document for reliability test conditions.

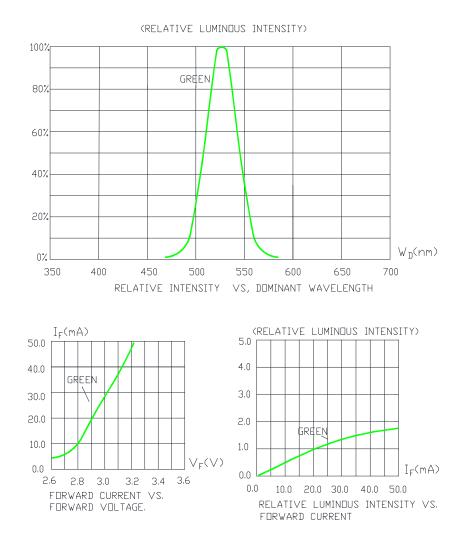
• Please refer to the HB LED Lamp Soldering & Handling document for information about how to use this LED product safely.

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## **GRAPHS**

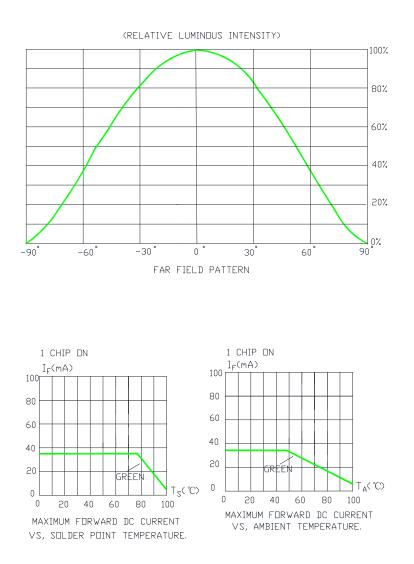
The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.





## **GRAPHS**

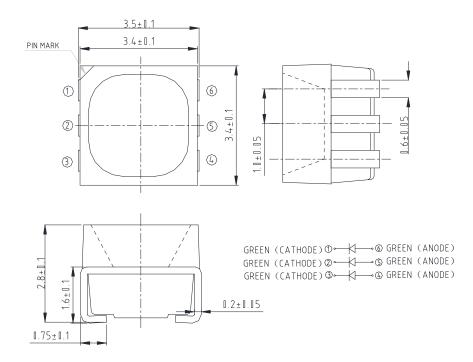
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## **MECHANICAL DIMENSIONS**

All dimensions are in mm.



#### NOTES

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the Product Ecology section of the Cree LED website.

#### **Vision Advisory**

WARNING: Do not look at an exposed lamp in operation. Eye injury can result.

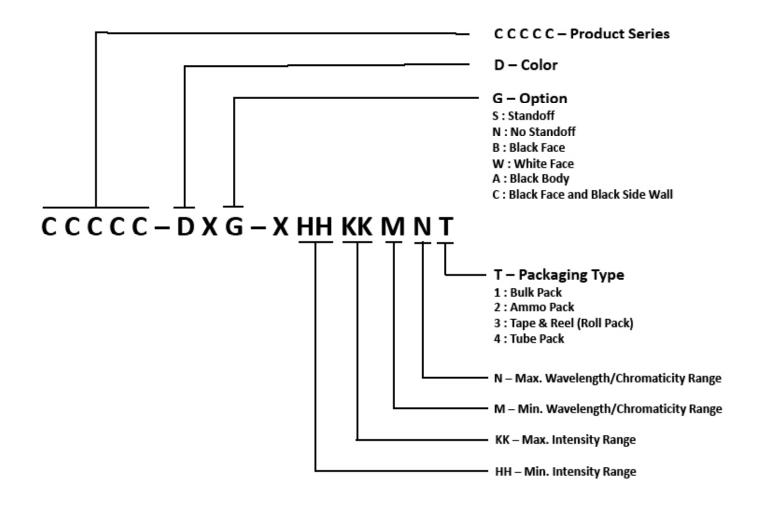
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### **KIT NUMBER SYSTEM**

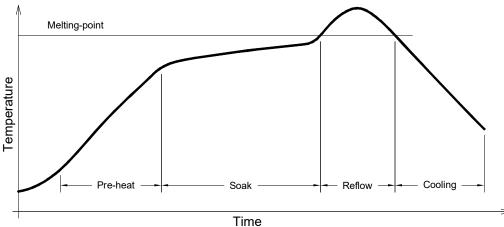
Cree LED lamps are tested and sorted into performance bins. A bin is specified by ranges of color, forward voltage, and brightness. Sorted LEDs are packaged for shipping in various convenient options.

Cree LEDs are sold by order codes in combinations of bins called kits. Order codes are configured in the following manner:



#### **REFLOW SOLDERING**

- The CLX6F-GKB is rated as a MSL 5a product. .
- The recommended floor life out of bag is 24hrs. .
- The temperature profile is as below. •

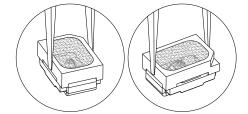




#### Use only with CLX6F-GKB

Solder
Average ramp-up rate = 4°C/s max
Preheat temperature = 150°C ~200°C
Preheat time = 120s max
Ramp-down rate = 6°C/s max
Peak temperature = 250°C max
Time within 5°C of actual Peak Temperature = 10s max
Duration above 217°C is 60s max

- The packaging sizes of these SMD products are very small and the resin is still soft after solidification. Users are required to handle • with care. Never touch the resin surface of SMD products.
- · To avoid damaging the product's surface and interior device, it is recommended to choose a special nozzle to pick up the SMD products during the process of SMT production. If handling is necessary, take special care when picking up these products. The following method is necessary:
- Please refer to the HB LED Lamp Soldering & Handling document for information about how to use this LED product safely. •





## PACKAGING

- · The LEDs are packed in cardboard boxes after packaging in normal or anti-electrostatic bags.
- Cardboard boxes will be used to protect the LEDs from mechanical shock during transportation.
- The boxes are not water resistant, and they must be kept away from water and moisture.
- The reel pack is applied in SMD LED.
- Max 2800 pcs per reel.

